

PRELIMINARY SPEC

Part Number: AA5060SEC/J

HYPER ORANGE

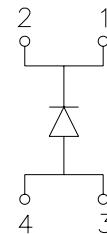
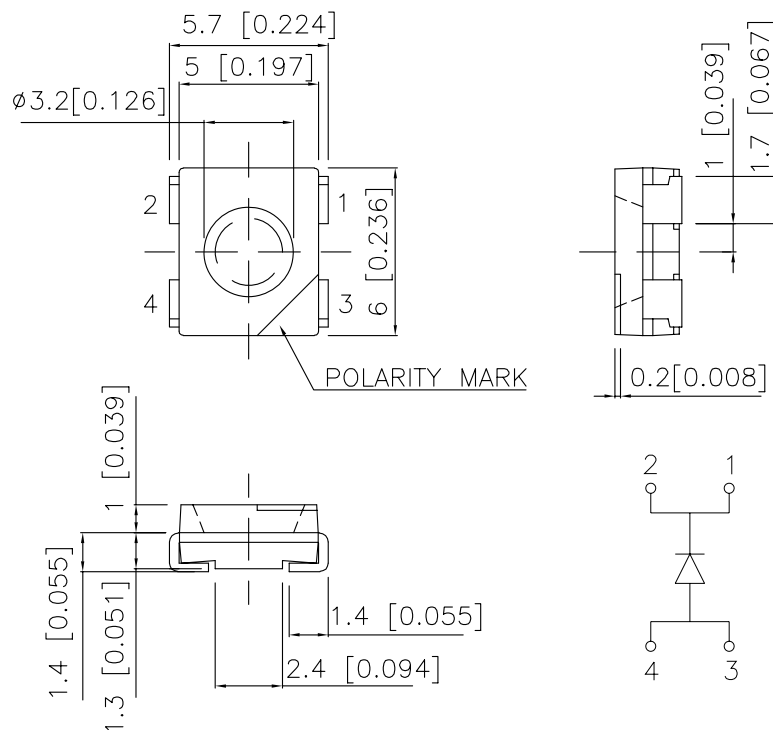
Features

- SINGLE COLOR.
- SUITABLE FOR ALL SMT ASSEMBLY AND SOLDER PROCESS.
- AVAILABLE ON TAPE AND REEL.
- IDEAL FOR BACKLIGHTING.
- PACKAGE : 500PCS / REEL.
- MOISTURE SENSITIVITY LEVEL : LEVEL 4.
- RoHS COMPLIANT.

Description

The Super Bright de vice is based on a light emitting diode chip made from AlGaInP and bonded on silicon substrate.

Package Dimensions



Notes:

1. All dimensions are in millimeters (inches).
2. Tolerance is ± 0.25 (0.01") unless otherwise noted.
3. Specifications are subject to change without notice.

Selection Guide

Part No.	Dice	Lens Type	Iv (mcd) [2] @ 20mA		Viewing Angle [1]
			Min.	TYP.	2θ1/2
AA5060SEC/J	HYPER ORANGE (AlGaInP)	WATER CLEAR	3200	4500	100°

Notes:

1. θ1/2 is the angle from optical centerline where the luminous intensity is 1/2 the optical centerline value.
2. Luminous intensity / luminous flux: +/-15%.

Electrical / Optical Characteristics at TA=25°C

Symbol	Parameter	Device	Typ.	Max.	Units	Test Conditions
λ _{peak}	Peak Wavelength	Hyper Orange	640		nm	I _F =20mA
λ _D [1]	Dominant Wavelength	Hyper Orange	630		nm	I _F =20mA
Δλ _{1/2}	Spectral Line Half-width	Hyper Orange	25		nm	I _F =20mA
C	Capacitance	Hyper Orange	27		pF	V _F =0V;f=1MHz
V _F [2]	Forward Voltage	Hyper Orange	2.2	2.8	V	I _F =20mA
I _R	Reverse Current	Hyper Orange		10	uA	V _R = 5V

Notes:

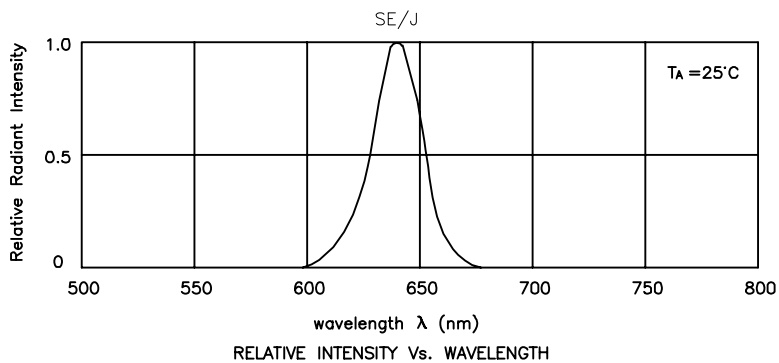
1. Wavelength: +/-1nm.
2. Forward Voltage: +/-0.1V.

Absolute Maximum Ratings at TA=25°C

Parameter	Hyper Orange	Units
Power dissipation	160	mW
DC Forward Current	50	mA
Peak Forward Current [1]	150	mA
Reverse Voltage	5	V
Operating/Storage Temperature	-40°C To +85°C	

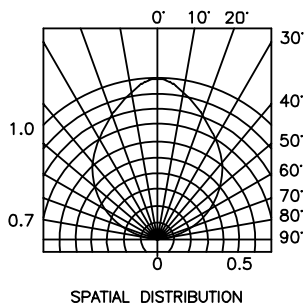
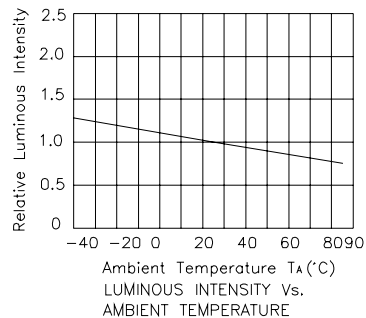
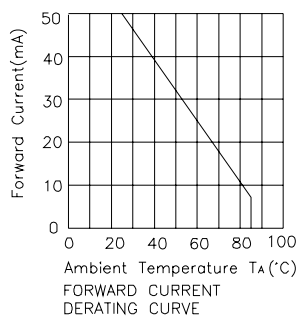
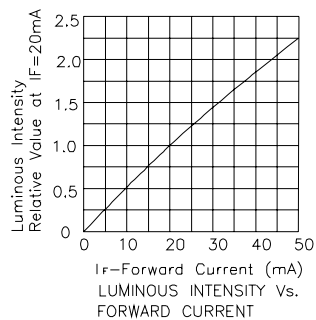
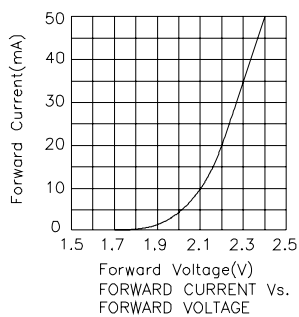
Note:

1. 1/10 Duty Cycle, 0.1ms Pulse Width.



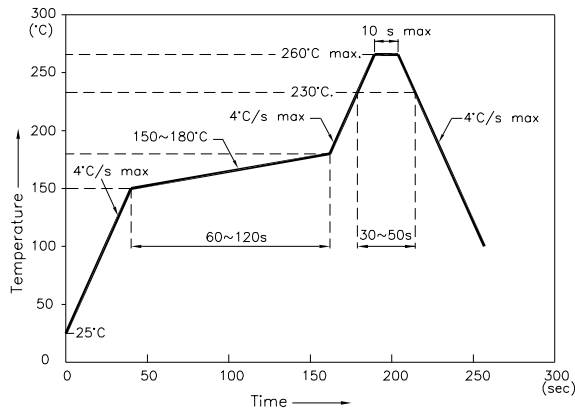
Hyper Orange

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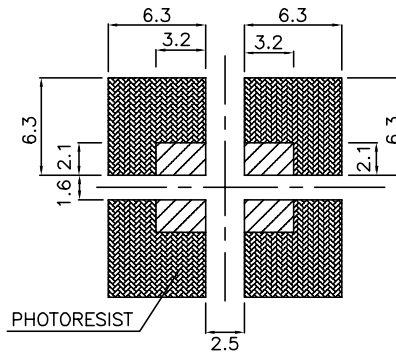
Reflow Soldering Profile For Lead-free SMT Process.



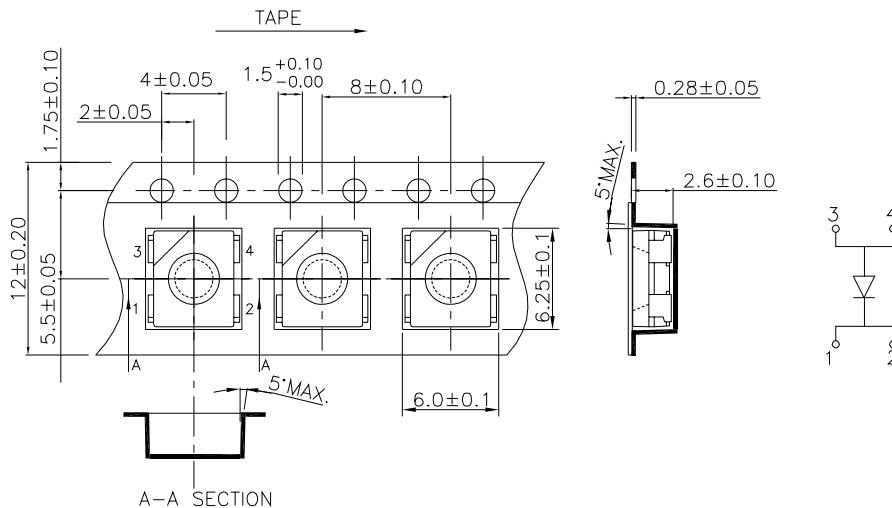
NOTES:

1. We recommend the reflow temperature 245°C(+/-5°C). The maximum soldering temperature should be limited to 260°C.
2. Don't cause stress to the epoxy resin while it is exposed to high temperature.
3. Number of reflow process shall be 2 times or less.

Recommended Soldering Pattern (Units : mm; Tolerance: ±0.1)

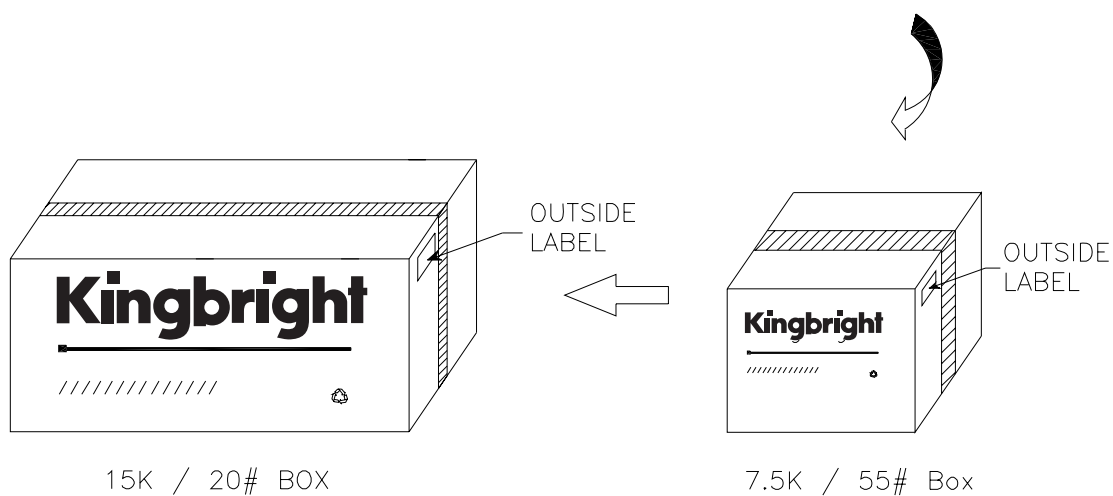
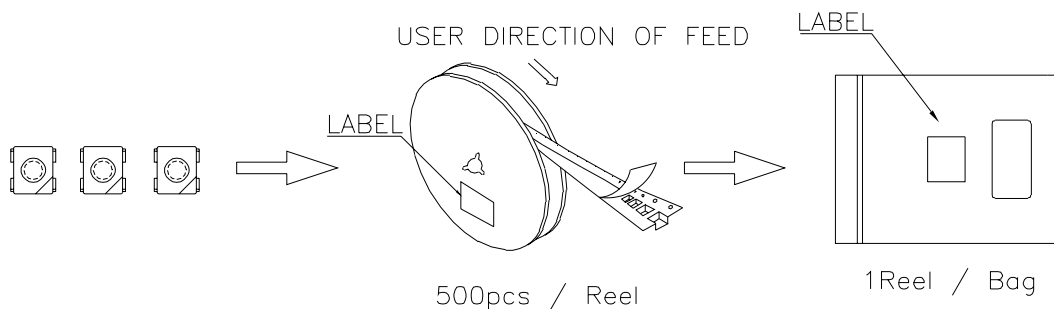



Tape Specifications (Units : mm)



PACKING & LABEL SPECIFICATIONS

AA5060SEC/J



<h1>Kingbright</h1>	
P/NO: AA5060xxx	
QTY: 500 pcs	Q.C. Q C xx-xx-xxxx PASSED
S/N: XXXX	
CODE: XXX	
LOT NO:	
 <small>xxxxxxxxxxxxxxxxxxxxxxxxxxxxxxxx</small>	
MADE IN CHINA	RoHS Compliant